# Logic

# LMA1009/2009

# 12 x 12-bit Multiplier-Accumulator

#### **FEATURES**

- 20 ns Multiply-Accumulate Time
- ☐ Low Power CMOS Technology
- ☐ Replaces TRW TDC1009/TMC2009
- ☐ Two's Complement or Unsigned Operands
- Accumulator Performs Preload, Accumulate, and Subtract
- ☐ Three-State Outputs
- ☐ DECC SMD No. 5962-90996
- ☐ Available 100% Screened to MIL-STD-883, Class B
- ☐ Package Styles Available:
  - 64-pin Sidebraze, Hermetic DIP
  - 68-pin Ceramic PGA
  - 68-pin Plastic LCC, J-Lead
  - 68-pin Ceramic LCC

#### DESCRIPTION

The LMA1009 and LMA2009 are high-speed, low power 12-bit multiplier-accumulators. They are pin-for-pin equivalent to the TRW TDC1009/TMC2009 multiplier-accumulators. The LMA1009 and LMA2009 are functionally identical; they differ only in packaging. Full ambient temperature range operation is achieved by the use of advanced CMOS technology.

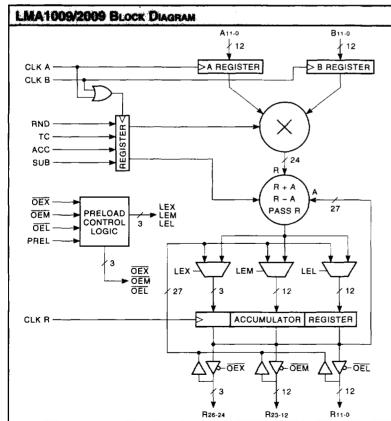
The LMA1009/2009 produces the 24-bit product of two 12-bit numbers. The results of a series of multiplications may be accumulated to form the sum of products. Accumulation is performed to 27-bit precision with the multiplier product sign extended as appropriate.

Data present at the A and B input registers is latched on the rising edges of CLK A and CLK B respectively. RND, TC, ACC, and SUB controls are latched on the rising edge of the logical OR of CLK A and CLK B. TC specifies the input as two's complement (TC HIGH) or unsigned magnitude (TC LOW). RND, when HIGH, adds '1' to the most significant bit position of the least significant half of the product. Subsequent truncation of the 12 least significant bits produces a result correctly rounded to 12-bit precision.

The ACC and SUB inputs control accumulator operation. ACC HIGH results in addition of the multiplier product and the accumulator contents, with the result stored in the accumulator register on the rising edge of CLK R. ACC and SUB HIGH results in subtraction of the accumulator contents from the multiplier product, with the result stored in the accumulator register. With ACC LOW, no accumulation occurs and the next product is loaded directly into the accumulator register.

The LMA1009/2009 output register (accumulator register) is divided into three independently controlled sections. The least significant result (LSR) and most significant result (MSR) registers are 12 bits in length. The extended result register (XTR) is 3 bits long.

Each output register has an independent output enable control. In addition to providing control of the three-state output buffers, when OEX, OEM, or OEL are HIGH and PREL is HIGH, data can be preloaded via the bidirectional output pins into the respective output registers. Data present on the output pins is latched on the rising edge of CLK R. The interrelation of PREL and the enable controls is summarized in Table 1.



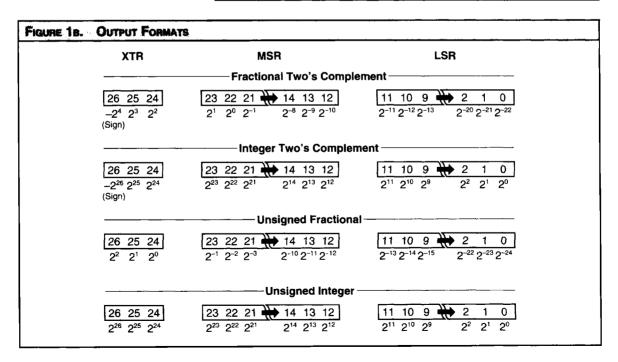


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TAB	LE 1.	PRE	LOAD	Thu	H TA	BLE
PREL	OEX	OEM	OEL	XTR	MSR	LSR
L	L	Ł	L	OUT	OUT	OUT
Ł	L	L	Н	OUT	OUT	z
L	L	Н	L	OUT	Z	OUT
Ł	L	Н	н	OUT	Z	z
L	н	L	L	Z	OUT	OUT
L	н	L	н	Z	OUT	z
L	Н	Н	L	Z	Z	OUT
L	Н	Н	н	Z	Z	Z
Н	L	L	L	Z	Z	Z
н	L	Ŀ	Н	Z	Z	PREL
н	Ĺ	Н	L	Z	PREL	Z
н	L	Н	Н	Z	PREL	PREL
н	Н	L	L	PREL	Z	Z
н	н	L	н	PREL	Z	PREL
н	н	Н	L	PREL	PREL	Z
н	н	Н	н	PREL	PREL	PREL

PREL = Preload data to appropriate register
OUT = Register available on output pins
Z = High impedance state

FIGURE 1A. INPUT FORMATS	
Ain	Bin
Fractional Two's Con	nplement (TC = 1)
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$
Integer Two's Com	plement (TC = 1)
11 10 9 2 1 0 -2 <sup>11</sup> 2 <sup>10</sup> 2 <sup>9</sup> 2 <sup>2</sup> 2 <sup>1</sup> 2 <sup>0</sup> (Sign)	11 10 9 2 1 0 -2 <sup>11</sup> 2 <sup>10</sup> 2 <sup>9</sup> 2 <sup>2</sup> 2 <sup>1</sup> 2 <sup>0</sup> (Sign)
	onal (TC = 0)
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$
	ger (TC = 0)
11 10 9 2 1 0 2 <sup>11</sup> 2 <sup>10</sup> 2 <sup>9</sup> 2 <sup>2</sup> 2 <sup>1</sup> 2 <sup>0</sup>	11 10 9 $\rightleftharpoons$ 2 1 0 2 <sup>11</sup> 2 <sup>10</sup> 2 <sup>9</sup> 2 <sup>2</sup> 2 <sup>1</sup> 2 <sup>0</sup>





## 12 x 12-bit Multiplier-Accumulator

Storage temperature	65°C to +150°C
Operating ambient temperature	55°C to +125°C
VCC supply voltage with respect to ground	0.5 V to +7.0 V
Input signal with respect to ground	3.0 V to +7.0 V
Signal applied to high impedance output	3.0 V to +7.0 V
Output current into low outputs	25 mA
Latchup current	> 400 mA

OPERATING CONDITIONS To meet spec	ified electrical and switching character	ristics
Mode	Temperature Range (Ambient)	Supply Voltage
Active Operation, Commercial	0°C to +70°C	$4.75~\text{V} \leq \text{V}\text{CC} \leq 5.25~\text{V}$
Active Operation, Military	−55°C to +125°C	4.50 V ≤ <b>V</b> CC ≤ 5.50 V

ELECTRICAL CHARACTERISTICS Over Operating Conditions (Note 4)										
Symbol	Parameter	Test Condition	Min	Тур	Max	Unit				
<b>V</b> OH	Output High Voltage	Vcc = Min., Iон = -2.0 mA	2.4			ν				
<b>V</b> OL	Output Low Voltage	VCC = Min., IOL = 8.0 mA			0.5	V				
<b>V</b> !H	Input High Voltage		2.0		Vcc	V				
<b>V</b> IL	Input Low Voltage	(Note 3)	0.0		8.0	٧				
lix	Input Current	Ground ≤ VIN ≤ VCC (Note 12)			±20	·μΑ				
loz	Output Leakage Current	Ground ≤ <b>V</b> OUT ≤ <b>V</b> CC (Note 12)			±20	μΑ				
ICC1	Vcc Current, Dynamic	(Notes 5, 6)		12	25	mA				
ICC2	Vcc Current, Quiescent	(Note 7)			1.0	mA				

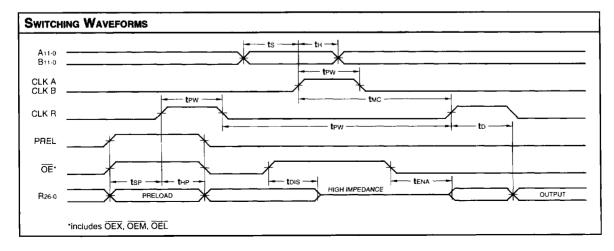


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#### **SWITCHING CHARACTERISTICS**

COMMERCIAL OPERATING RANGE (0°C to +70°C) Notes 9, 10 (ns)										
			LMA1009/2009-							
		7	75 55 45						0	
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Min	Max	
tMC	Clocked Multiply Time	į	75		55		45		20	
tpw	Clock Pulse Width	15		15		15		8		
ts	Input Register Setup Time	15		15		12		10		
tн	Input Register Hold Time	2		2		2	T	2	!	
<b>t</b> SP	Preload Setup Time	15		15		12	1	10		
tHP	Preload Hold Time	2	:	2		2		2		
<b>t</b> D	Output Delay		30		25		25		18	
<b>t</b> ENA	Three-State Output Enable Delay (Note 11)		30		30		25		18	
tDIS	Three-State Output Disable Delay (Note 11)		25		25	Ī -	25		18	

MILITAR	Y OPERATING RANGE (-55°C to +125°C) No	tes 9, 10 (ns)								
			LMA1009/2009-							
Symbol		9	5	65 55					5	
	Parameter	Min	Max	Min	Max	Min	Max	Min	Max	
tMC	Clocked Multiply Time		95		65		55		25	
tew	Clock Pulse Width	20		20		15		10		
ts	Input Register Setup Time	20		20		15		12		
tн	Input Register Hold Time	2		2		2	!	2	1	
tsp	Preload Setup Time	20	T	20		15		12		
<b>t</b> HP	Preload Hold Time	2		2		2		2	1	
<b>t</b> D	Output Delay		35		30		25		20	
tENA	Three-State Output Enable Delay (Note 11)		35		35		30		20	
tDIS	Three-State Output Disable Delay (Note 11)		30		30		30		20	





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#### NOTES

- 1. Maximum Ratings indicate stress specifications only. Functional operation of these products at values beyond those indicated in the Operating Conditions table is not implied. Exposure to maximum rating conditions for extended periods may affect reliability.
- 2. The products described by this specification include internal circuitry designed to protect the chip from damaging substrate injection currents and accumulations of static charge. Nevertheless, conventional precautions should be observed during storage, handling, and use of these circuits in order to avoid exposure to excessive electrical stress values.
- 3. This device provides hard clamping of transient undershoot and overshoot. Input levels below ground or above VCC will be clamped beginning at -0.6 V and VCC + 0.6 V. The device can withstand indefinite operation with inputs in the range of -0.5 V to +7.0 V. Device operation will not be adversely affected, however, input current levels will be well in excess of 100 mA.
- 4. Actual test conditions may vary from those designated but operation is guaranteed as specified.
- 5. Supply current for a given application can be accurately approximated by:

NCV2F

where

N = total number of device outputs

C = capacitive load per output

V = supply voltage

F = clock frequency

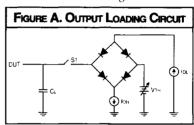
- 6. Tested with all outputs changing everv cycle and no load, at a 5 MHz clock rate.
- 7. Tested with all inputs within 0.1 V of VCC or Ground, no load.
- 8. These parameters are guaranteed but not 100% tested.

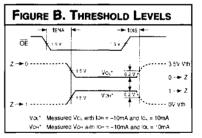
9. AC specifications are tested with input transition times less than 3 ns. output reference levels of 1.5 V (except tDIS test), and input levels of nominally 0 to 3.0 V. Output loading may be a resistive divider which provides for specified IOH and IOL at an output voltage of VOH min and VOL max respectively. Alternatively, a diode bridge with upper and lower current sources of IOH and IOL respectively. and a balancing voltage of 1.5 V may be used. Parasitic capacitance is 30 pF minimum, and may be distributed.

This device has high-speed outputs capable of large instantaneous current pulses and fast turn-on/turn-off times. As a result, care must be exercised in the testing of this device. The following measures are recommended:

- a. A 0.1 µF ceramic capacitor should be installed between VCC and Ground leads as close to the Device Under Test (DUT) as possible. Similar capacitors should be installed between device VCC and the tester common, and device ground and tester common.
- b. Ground and VCC supply planes must be brought directly to the DUT socket or contactor fingers.
- c. Input voltages should be adjusted to compensate for inductive ground and VCC noise to maintain required DUT input levels relative to the DUT ground pin.
- 10. Each parameter is shown as a minimum or maximum value. Input requirements are specified from the point of view of the external system driving the chip. Setup time, for example, is specified as a minimum since the external system must supply at least that much time to meet the worst-case requirements of all parts. Responses from the internal circuitry are specified from the point of view of the device. Output delay, for example, is specified as a maximum since worst-case operation of any device always provides data within that time.

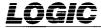
- 11. For the tENA test, the transition is measured to the 1.5 V crossing point with datasheet loads. For the tDIS test, the transition is measured to the ±200mV level from the measured steady-state output voltage with ±10mA loads. The balancing voltage, VTH, is set at 3.5 V for Z-to-0 and 0-to-Z tests, and set at 0 V for Zto-1 and 1-to-Z tests.
- 12. These parameters are only tested at the high temperature extreme, which is the worst case for leakage current.





# 12 x 12-bit Multiplier-Accumulator

	LMA1009 — ORDERING INFORMATION	ı -			<u></u>	<u>:</u>							
	64-pin	68-	pin										
	A4 1 64 A5												
	A3 ☐ 2 63 ☐ A6 A2 ☐ 3 62 ☐ A7		1	2	3	4	5	6	7	8	9	10	11
	A1 [] 4 61 [] A8 A0 [] 5 60 [] A9		·										
	ACC ☐ 6 59 ☐ A10	A	▼	08	O	ACC	Ô	Õ	Õ	$\circ$	Ö	0	
	SUB []7 58 [] A11 AND []8 57 [] CLK A	В	0	Ĉ.	SUB	AO Ao	Õ	A3	A5	Ā	Ã9	CLK A	0
	ŌEL □9 56 □ CLKB Ro □ 10 55 □ Bo	c	Ro	OEE ()	SUB	<b>A</b> o	<b>A</b> 2	<b>A</b> 4	A <sub>6</sub>	As	<b>A</b> 10	CLŘ /	NC O
	R1 ☐ 11 54 ☐ B1 R2 ☐ 12 53 ☐ B2		) <sub>8</sub> ()	Ri							1	Bo	CLK B
	R3 [] 13 52 [] B3 R4 [] 14 51 [] B4	D		() B3								⊖ 82	O Bi
	R5 ☐ 15 50 ☐ B5	E	R <sub>4</sub>				,	op Vie	r		1	$\circ$	$\circ$
	GND ☐ 16 49 ☐ VCC Re ☐ 17 48 ☐ Be	F	GND ()	R <sub>5</sub>				ıgh Pa			ļ	B₄ (``)	<b>D</b> 3
	R7	_	R <sub>7</sub>	Rб		(ı.e.,	Comp	onent	Side P	inout)	ļ	V00	B5
	Re ☐ 20 45 ☐ 89 Rio ☐ 21 44 ☐ 810	G	C) R9	() Ra									O Bs
	R11 22 43 B11 CLK R 223 42 TC	н	0	0								$\circ$	$\circ$
	PREL 324 41 0EX	J	Ri O	R <sub>10</sub>								B <sub>0</sub>	Be
	R12 ☐ 26 39 ☐ R25	к	PREL	CLKF		0	0	0	0	0	0	Bii	B10
	R13	1	NC	OEM	R13	R15	R17	H19	R21	<b>R</b> 23	R <sub>25</sub>		TC
	R15 [ 29 36 ] R22 R16 [ 30 35 ] R21	L	ŀ	() R12		() R16	O Ria	() R20	() R22	() R24	() A26	O <sub>NC</sub>	
	R17										7120	.,,,	
	* 64-pin DIP not recommended for new designs												
eed	Sidebraze Hermetic DIP (D6)	-			C	eran		in G	rid A	Array	,		
	0°C to +70°C — COMMERCIAL SCREENING	<u> </u>						(LE)		•			
ns	LMA1009DC75	Π				L	MA1	0090	C75	5			
ns	LMA1009DC55						MA1						
ns ns	LMA1009DC45						MA1 MA1						
113						_	IVIPS I	0090	اعراد	,			
	-55°C to +125°C Commercial Screening	L											
	LMA1009DM95					L	MA1	0090	M95	5			
ns	2						MA1						
ns ns	LMA1009DM65						MA1 MA1						
ns ns						•	ואוייי	VUJL	11412	J			
ns ns	LMA1009DM65					L.							
ns ns	LMA1009DM65										•		
ns ns ns	LMA1009DM65 LMA1009DM55						MA10	009G	MB9	95			
ns ns ns	LMA1009DM65 LMA1009DM55  -55°C to +125°C MIL-STD-883 COMPLIANT LMA1009DMB95 LMA1009DMB65					LN	/A10	)09G	MB6	35			
ns ns ns	LMA1009DM65 LMA1009DM55  -55°C to +125°C MIL-STD-883 COMPLIANT LMA1009DMB95			• •			<b>ЛА</b> 10	)09G )09G	MB6 MB5	65 65			



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